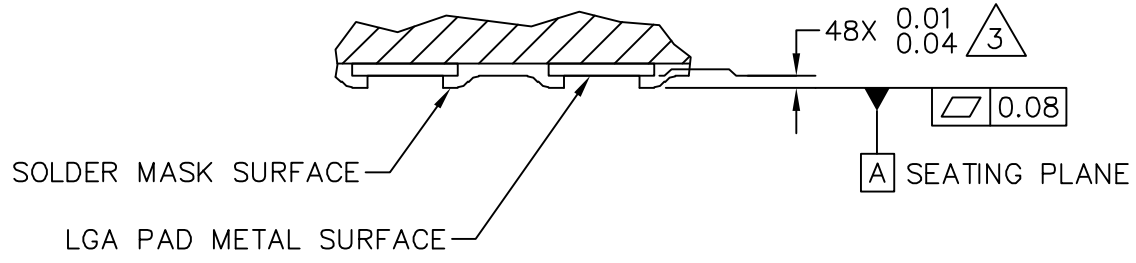


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| TITLE: MAPLGA, THIN PROFILE, FINE PITCH, 44 I/O, 5 X 5 PKG, 0.65 MM PITCH (LAMINATE QFN) | DOCUMENT NO: 98ASA00239D | REV: D |
| | STANDARD: NON-JEDEC | |
| | SOT1638-1 | 06 JAN 2016 |



DETAIL D
VIEW ROTATED 90° CW

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| TITLE: MAPLGA, THIN PROFILE, FINE PITCH, 44 I/O, 5 X 5 PKG, 0.65 MM PITCH (LAMINATE QFN) | | DOCUMENT NO: 98ASA00239D | REV: D |
| | | STANDARD: NON-JEDEC | |
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NOTES:

1. ALL DIMENSIONS IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.

3. DIMENSION APPLIES TO ALL LEADS AND FLAG AREAS.
4. PARALLELISM MEASUREMENT SHALL EXCLUDE ANY EFFECT OF MARK ON TOP SURFACE OF PACKAGE.

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